

# INDUSTRIAL ADVISORY COMMITTEE (IAC) MEETING

## AGENDA

June 6<sup>th</sup>, 2023

**Location:** District Ballroom Mayflower Hotel Washington, DC

### MEETING GOALS:

- Provide an update on the CHIPS Act Implementation
- Receive recommendations from the IAC working groups
- Allow the Committee to deliberate and discuss the progress that has been made

June 6, 2023		
Time (ET)	Topic	Discussion Leader
9:30 am to 9:35 am	Call to Order Roll Call	<b>Ben Davis</b> <i>IAC Designated Federal Officer</i> NIST  <b>Tamiko Ford</b> <i>IAC Designated Federal Officer</i> NIST
9:35 am to 9:45 am	Welcome Opening Remarks	<b>Michael Splinter</b> <i>IAC Chair</i> General Partner MRS Business and Technology Advisors  <b>Susan Feindt</b> <i>IAC Vice-Chair</i> Fellow Analog Devices Inc.
9:45 am to 9:55 am	Welcome Remarks	<b>Laurie Locascio</b> <i>Under Secretary of Commerce for Standards and Technology</i> NIST
9:55 am to 10:20 am	<a href="#">CHIPS R&amp;D Update</a>	<b>Eric Lin</b> <i>Interim CHIPS R&amp;D Director</i> NIST  <b>Marla Dowell</b> <i>CHIPS Metrology Director</i> NIST
10:20 am to 10:40 am	<a href="#">CHIPS Act and National Microelectronics Strategy Presentation</a>	<b>Lisa E. Friedersdorf</b> <i>Assistant Director for Microelectronics, Materials, and Critical Minerals</i> Office of Science and Technology Policy White House
10:40 am to 11:00 am	Microelectronics Programs and Intra-agency Coordination Presentation <ul style="list-style-type: none"><li>• <a href="#">DoD Presentation</a></li><li>• <a href="#">DoE Presentation</a></li></ul>	<b>Alison Smith</b> <i>Microelectronics Commons Technical Director</i> Office of the Under Secretary of Defense for Research and Engineering  <b>Barry Johnson</b> <i>Division Director, Division of Translational Impacts</i> National Science Foundation  <b>Andrew Schwartz</b> <i>Division Director, Material Sciences and Engineering Division</i> Basic Energy Sciences Office of Science Department of Energy

11:00 pm to 12:00 pm	Government Roundtable	<b>Lisa E. Friedersdorf</b> <b>Alison Smith</b> <b>Barry Johnson</b> <b>Andrew Schwartz</b> <b>Eric Lin</b>  <b>Christie Canaria</b> <i>CHIPS R&amp;D Program Manager</i> NIST
12:15 pm to 1:00 pm	Lunch	<b>Ben Davis</b>
1:00 pm to 1:15 pm	DOC Remarks	<b>Gina Raimondo</b> <i>Secretary of Commerce</i> DOC
1:15 pm to 1:45 pm	<a href="#">Sequencing Working Group Report Out and Discussion Presentation</a>	<b>Willy Shih</b> <i>Sequencing Working Group Chair</i> Harvard Business School
1:45 pm to 2:30 pm	<a href="#">Organizational and PPP Working Group Report Out and Discussion Presentation</a>	<b>Deirdre Hanford</b> <i>Organizational and Public &amp; Private Partnerships Working Group Chair</i> Synopsis
2:30 pm to 2:45 pm	Break	<b>Ben Davis</b>
2:45 pm to 3:30 pm	<a href="#">R&amp;D Workforce Working Group Report Out and Discussion Presentation</a>	<b>Tsu-Jae King Liu</b> <i>Workforce Working Group Chair</i> University of California Berkeley
3:30 pm to 4:15 pm	<a href="#">R&amp;D Gaps Working Group Report Out and Discussion Presentation</a>	<b>Dan Armbrust</b> <i>R&amp;D Working Group Chair</i> Silicon Catalyst
4:15 pm to 4:25 pm	Public Comment Period	<b>Ben Davis</b>
4:25 pm to 4:30 pm	Summary Remarks and Next Steps	<b>Laurie Locascio</b>
4:30 pm	Adjourn	<b>Ben Davis</b>